

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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October 2013

DFB2005 - DFB20100 Glass-Passivated Bridge Rectifiers

Features

- UL Certificate: # E258596
- · Glass-Passivated Junction
- · Ideal for Printed Circuit Board
- · Reliable Low-Cost Construction
- Plastic Material has Underwriters Laboratory Flammability Classification 94V-0
- Surge Overload Rating to 250 A Peak
- High Case Dielectric Strength: 2000 V_{RMS}
- Isolated Voltage from Case to Lead: > 2500 V



TS-6P

Ordering Informations

Part Number	Marking	Package	Packing Method
DFB2005	DFB2005		
DFB2010	DFB2010		
DFB2020	DFB2020		
DFB2040	DFB2040	TS-6P 4L	Rail
DFB2060	DFB2060		
DFB2080	DFB2080		
DFB20100	DFB20100		

Absolute Maximum Ratings(1)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25$ °C unless otherwise noted.

		Value							
Symbol	Parameter	DFB 2005	DFB 2010	DFB 2020	DFB 2040	DFB 2060	DFB 2080	DFB 20100	Units
V _{RRM}	Maximum Recurrent Peak Reverse Voltage	50	100	200	400	600	800	1000	V
V _{RMS}	Maximum RMS Voltage	35	70	140	280	420	560	700	V
V _{DC}	Maximum DC Blocking Voltage	50	100	200	400	600	800	1000	V
I _(AV)	Maximum Average Forward Rectified Current				20				Α
I _{FSM}	Peak Forward Surge Current (8.3 ms Single Half-wave)				250				Α
$R_{\theta JC}$	Typical Thermal Resistance ⁽²⁾			4.75				°C/W	
TJ	Operating Temperature Range	-55 to +150		50		°C			
T _{STG}	Storage Temperature Range			-55 to +150				°C	

Notes:

- 1. Single-phase, half-wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.
- 2. Device mounted on 4 inch x 5 inch x 0.25 inch Al-plate heat sink.

Electrical Characteristics

Values are at T_A = 25°C unless otherwise specified.

Symbol	Parameter	Test condition	Value	Unit	
V _F	Maximum	10 A	1.0	V	
	Instantaneous Forward Voltage	20 A	1.1		
I _R	Maximum DC Reverse Current at Rated DC Blocking Voltage	T _A = 25°C	10	uΑ	
		T _A = 125°C	500	μΛ	
I ² t	Rating for Fusing (t < 8.3 ms)		259	A ² s	
СЈ	Typical Junction Capacitance per L	140	pF		

Note:

3. Measured at 1 MHz and applied reverse bias of 4.0 V DC.

Typical Performance Characteristics

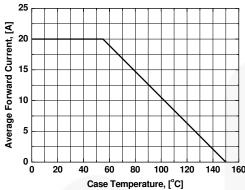


Figure 1. Maximum Derating Curve for Output Current

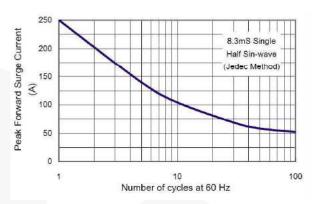


Figure 2. Maximum Forward Surge Current per Leg

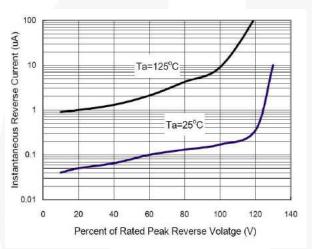


Figure 3. Typical Reverse Characteristics per Leg

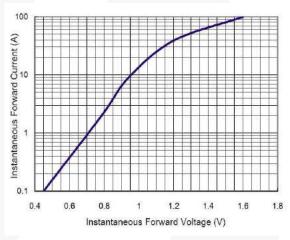


Figure 4. Typical Forward Characteristics per Leg

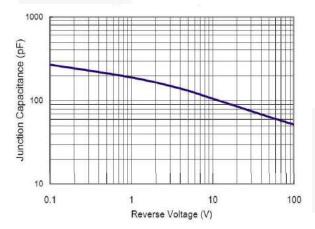
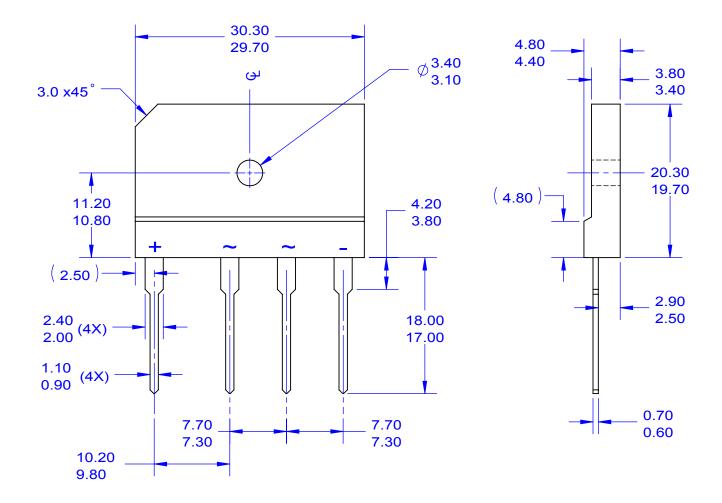


Figure 5. Typical Junction Capacitance



NOTES:

- A. THIS PACKAGE DOES NOT CONFORM TO
- ANY STANDARDS.

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